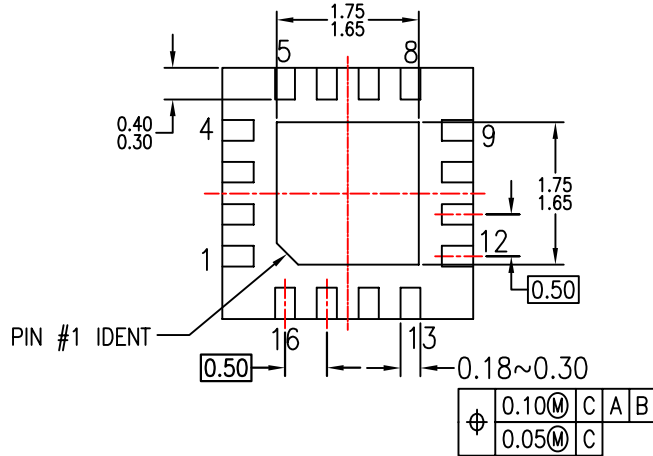
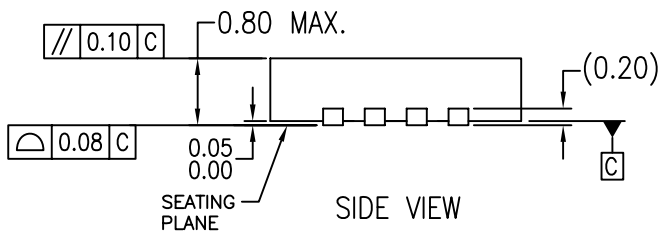
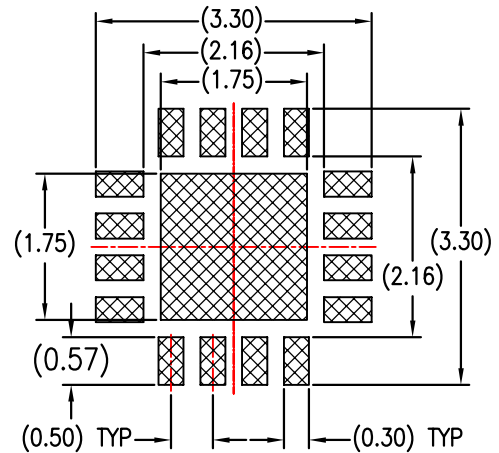
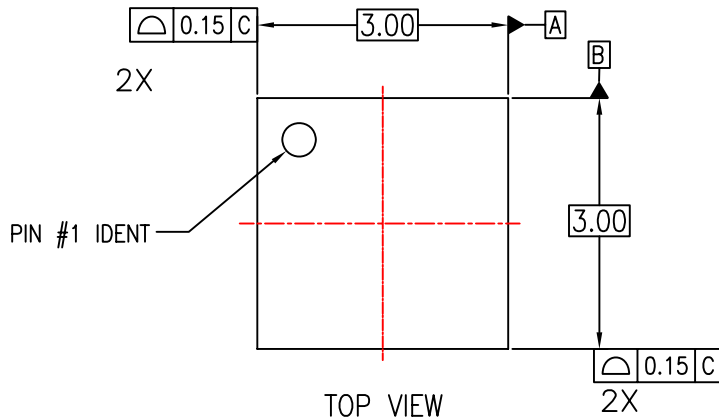


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REVISIONS				
LTR	DESCRIPTION	EDCN	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	ECN-MKT-MLP16B	21-2-05	FEITAN
B	Lead length Changed from 0.35-0.45 to 0.30-0.40	ECN-MKT-MLP16B revB	10-6-05	Jkingsbury



NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-220, VARIATION WEED-Pending, DATED pending
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
- D. DIMENSIONS ARE EXCLUSIVE OF BURS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

MLP16BrevB

APPROVALS	DATE		Bayan Lepas, FIZ, 11900, Penang, Malaysia.		
DRAWN FEITAN	18-2-2005			16LD, MLP, QUAD, JEDEC MO-220, 3MM SQUARE	
DFTG. CHK. J. KINGSBURY	6-6-2005				
ENGR. CHK. D. CHONG	6-6-2005				
		SCALE	SIZE	DRAWING NUMBER	REV
		N/A	N/A	MKT-MLP16B	B
DO NOT SCALE DRAWING				SHEET 1 of 1	